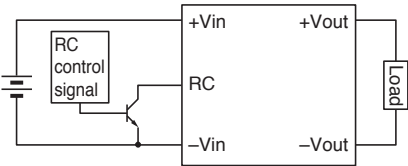


CC-E Instruction Manual

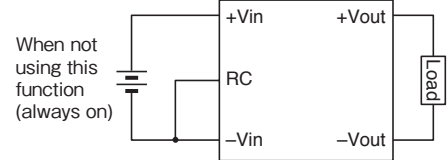
1. Control functions/Protection functions/Connections

1. Remote On/Off terminal (RC)

Open collector is recommended as the connection system. Consult us for use with other systems. Use a transistor with "VCE: Vin or over" and "Ic: 1mA or over". Output is switched off by setting the RC terminal open, and switched on by setting the RC terminal to LOW (0-0.4V).



When not using this function (always on), short-circuit between RC terminal and -Vin terminal.



1-2. Output voltage adjusting terminal (TRM)

Output voltage can be set to the values shown in the figure below by connecting the TRM terminal to the -Vout terminal. When not using this function, set the TRM terminal to open. Note that when the output voltage is set high by this function, derating of output current is necessary according to the maximum power.

DIP/SMD models

Model name	Open	Connection to -Vout	Fig.
CC*-xx03Sx-E	3.3V	3.6V	1
CC*-xx05Sx-E	5V	6V	1
CC*-xx12Sx-E	12V	15V	1
CC*-xx12Dx-E	±12V	±15V	2

* To be replaced with 1R5(1.5W), 3(3W), 6(6W), or 10(10W) for actual model names.

Fig.1

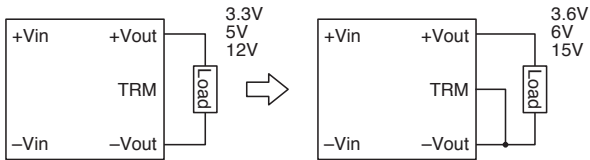
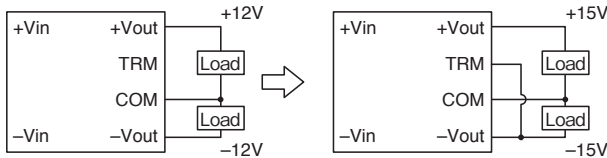


Fig.2



SIP models

Model name	Model name	Connection to -Vout	Fig.
CC3-xx03SS-E	3.3V	3.67V	3
CC3-xx05SS-E	5V	6V	3
CC3-xx12SS-E	12V	15V	3
CC3-xx12DS-E	±12V	±15V	4

Fig.3

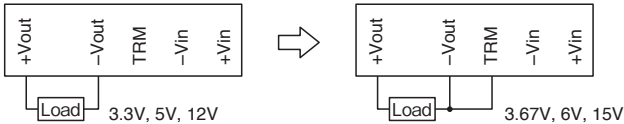
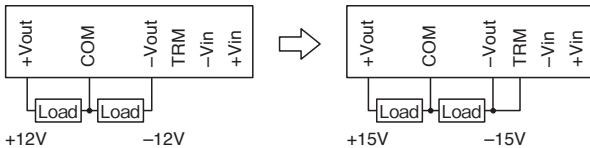


Fig.4



For the $\pm 12\text{V}$ output model, output voltage can be set to 24V single output by making the COM terminal and TRM terminal open. And output voltage can be set to 30V single output by making the COM terminal open and connecting the TRM terminal to the $-V_{\text{out}}$ terminal.

DIP/SMD models

Model name	COM terminal	TRM terminal	Single output	Fig.
CC*-xx12Dx-E	Open	Open	24V	5
	Open	Connection to $-V_{\text{out}}$	30V	6

* To be replaced with 1R5(1.5W), 3(3W), 6(6W), or 10(10W) for actual model names.

Fig.5

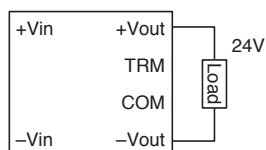
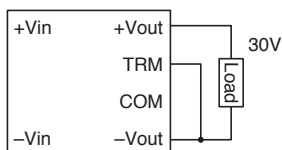


Fig.6



SIP models

Model name	COM terminal	TRM terminal	Single output	Fig.
CC3-xx12DS-E	Open	Open	24V	7
	Open	Connection to $-V_{\text{out}}$	30V	8

Fig.7

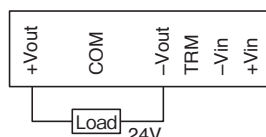
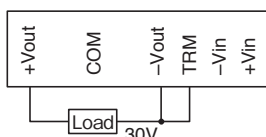


Fig.8



1-3. Output voltage adjusting function (adding external resistance)

Output voltage can be varied in the range shown in the figure below by connecting a resistance (R_a , R_b) between the TRM terminal and the $-V_{\text{out}}$ terminal or between the TRM terminal and $+V_{\text{out}}$ terminal.

Note that when the output voltage is set high, derating of output current is necessary according to the maximum power.

DIP/SMD models

Model name	Connection between $-V_{\text{out}}$ and R_a	Fig.	Connection between $+V_{\text{out}}$ and R_b	Fig.
CC*-xx03Sx-E	3.3 to 3.6V^{*1}	9	3.15 to 3.3V^{*5}	10
CC*-xx05Sx-E	5 to 6V^{*2}	9	4.75 to 5V^{*6}	10
CC*-xx12Sx-E	12 to 15V^{*3}	9	11.4 to 12V^{*7}	10
CC*-xx12Dx-E	± 12 to $\pm 15\text{V}^{*4}$	11	± 11.4 to $\pm 12\text{V}^{*8}$	12

* To be replaced with 1R5(1.5W), 3(3W), 6(6W), or 10(10W) for actual model names.

Calculating output voltage V_{out} (V) from connected resistance R_a , R_b (k Ω)

Adding a resistance R_a between TRM terminal and $-V_{\text{out}}$ terminal, to set the output voltage high

- *1 $V_{\text{out}} = 3.3 + 9.59/(32+R_a)$
- *2 $V_{\text{out}} = 5.01 + 17.64/(17.8+R_a)$
- *3 $V_{\text{out}} = 12.01 + 50.53/(16.9+R_a)$
- *4 $V_{\text{out}} = 12.02 + 53.55/(18+R_a)$

Adding a resistance R_b between TRM terminal and $+V_{\text{out}}$ terminal, to set the output voltage low

- *5 $V_{\text{out}} = 3.3 - 15.53/(39.6+R_b)$ [$R_b \geq 62$]
- *6 $V_{\text{out}} = 5.01 - 52.55/(31.8+R_b)$ [$R_b \geq 160$]
- *7 $V_{\text{out}} = 12.01 - 431.1/(57+R_b)$ [$R_b \geq 620$]
- *8 $V_{\text{out}} = 12.02 - 968.5/(103+R_b)$ [$R_b \geq 1500$]

Calculating connected resistance R_a , R_b (k Ω) from set output voltage V_{out} (V)

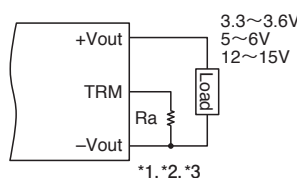
Adding a resistance R_a between TRM terminal and $-V_{\text{out}}$ terminal, to set the output voltage high

- *1 $R_a = 9.59/(V_{\text{out}}-3.3) - 32$
- *2 $R_a = 17.64/(V_{\text{out}}-5.01) - 17.8$
- *3 $R_a = 50.53/(V_{\text{out}}-12.01) - 16.9$
- *4 $R_a = 53.55/(V_{\text{out}}-12.02) - 18$

Adding a resistance R_b between TRM terminal and $+V_{\text{out}}$ terminal, to set the output voltage low

- *5 $R_b = 15.53/(3.3-V_{\text{out}}) - 39.6$
- *6 $R_b = 52.55/(5.01-V_{\text{out}}) - 31.8$
- *7 $R_b = 431.1/(12.01-V_{\text{out}}) - 57$
- *8 $R_b = 968.5/(12.02-V_{\text{out}}) - 103$

Fig.9



*1, *2, *3

Fig.10

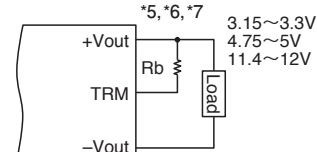
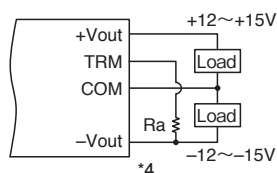
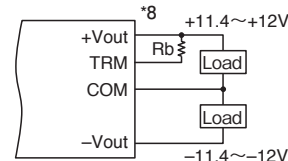


Fig.11



*4

Fig.12



SIP models

Model name	Connection between $-V_{\text{out}}$ and R_a	Fig.	Connection between $+V_{\text{out}}$ and R_b	Fig.
CC3-xx03SS-E	3.3 to 3.6V^{*1}	13	3.15 to 3.3V^{*5}	14
CC3-xx05SS-E	5 to 6V^{*2}	13	4.75 to 5V^{*6}	14
CC3-xx12SS-E	12 to 15V^{*3}	13	11.4 to 12V^{*7}	14
CC3-xx12DS-E	± 12 to $\pm 15\text{V}^{*4}$	15	± 11.4 to $\pm 12\text{V}^{*8}$	16

* To be replaced with 1R5(1.5W), 3(3W), 6(6W), or 10(10W) for actual model names.

Calculating output voltage V_{out} (V) from connected resistance R_a , R_b (k Ω)

Adding a resistance R_a between TRM terminal and $-V_{\text{out}}$ terminal, to set the output voltage high

- *1 $V_{\text{out}} = 3.3 + 1.04/(2.83+R_a)$
- *2 $V_{\text{out}} = 5 + 12.75/(12.69+R_a)$
- *3 $V_{\text{out}} = 12 + 48.4/(16.18+R_a)$
- *4 $V_{\text{out}} = 12 + 54.7/(18+R_a)$

Adding a resistance R_b between TRM terminal and $+V_{\text{out}}$ terminal, to set the output voltage low

- *5 $V_{\text{out}} = 3.3 - 1.69/(3.66+R_b)$ [$R_b \geq 7.6$]
- *6 $V_{\text{out}} = 5 - 12.78/(17.79+R_b)$ [$R_b \geq 33.3$]
- *7 $V_{\text{out}} = 12 - 184.1/(35.54+R_b)$ [$R_b \geq 271.3$]
- *8 $V_{\text{out}} = 12 - 470.3/(61.75+R_b)$ [$R_b \geq 722.1$]

Calculating connected resistance Ra, Rb (kΩ) from set output voltage Vout (V)

Adding a resistance Ra between TRM terminal and -Vout terminal, to set the output voltage high

- *1 $R_a = 1.04 / (V_{out} - 3.3) - 2.83$
- *2 $R_a = 12.75 / (V_{out} - 5) - 12.69$
- *3 $R_a = 48.4 / (V_{out} - 12) - 16.18$
- *4 $R_a = 54.7 / (V_{out} - 12) - 18$

Adding a resistance Rb between TRM terminal and +Vout terminal, to set the output voltage low

- *5 $R_b = 1.69 / (3.3 - V_{out}) - 3.66$
- *6 $R_b = 12.78 / (5 - V_{out}) - 17.79$
- *7 $R_b = 184.1 / (12 - V_{out}) - 35.54$
- *8 $R_b = 470.3 / (12 - V_{out}) - 61.75$

Fig.13

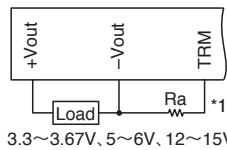


Fig.14

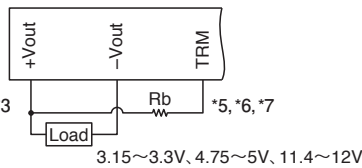


Fig.15

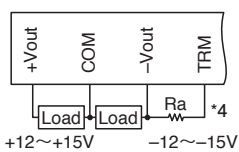
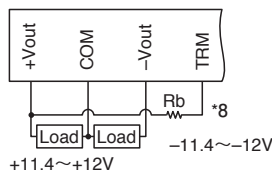


Fig.16



1-4. Over current protection

An over current protection circuit is incorporated in the model, and if over current occurs, the output voltage is lowered. By removing the over current (105% to 250% of rated output current) conditions, the output voltage automatically resumes. Note that if the over current status continues for 30 seconds or over, the internal elements of the converter may be deteriorated or damaged. The current value, from which it is judged as an over current, is not to be lower than the nominal current value. Due to fold back characteristics of OCP, the output may not rise up steady with constant current load or inductive load.

1-5. Over voltage protection

An over voltage protection function is not incorporated in the model. Be careful if an external voltage over the nominal voltage is applied, damage may be caused.

1-6. Low input voltage protection

This series is equipped with the low input voltage protection in order to prevent malfunction due to low input voltage. The converter stops operation if the input voltage become lower than the set voltage. The set ranges are shown in the table below.

Model name	Input voltage range	Voltage range set for protection circuit
CC*-05xxx-E	4.5 to 9V	3 to 4.5V
CC*-12xxx-E	9 to 18V	6 to 9V
CC*-24xxx-E	18 to 36V	13 to 18V
CC*-48xxx-E	36 to 76V	27 to 36V

* To be replaced with 1R5(1.5W), 3(3W), 6(6W), or 10(10W) for actual model names.

The above setting value is fixed and cannot be adjusted externally.

1-7. Insulation withstand voltage

The insulation withstand voltage between input and output, and between terminal and case, is AC500V.

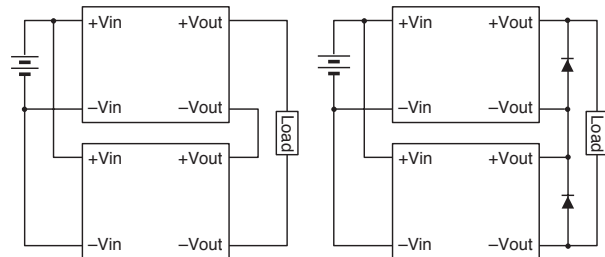
1-8. Series/Parallel connections

Series connection

Serial connection is applicable by wiring as shown in the figure below (left). If output voltage is not generated by this connection, connect a Schottky barrier diode in which the forward voltage is possibly low.

Also note that the Schottky barrier diode should have a reverse voltage that is twice or over the value of the voltage between +Vout and -Vout.

And the output current should be the same or lower than the nominal current value, whichever is smaller in the converters.



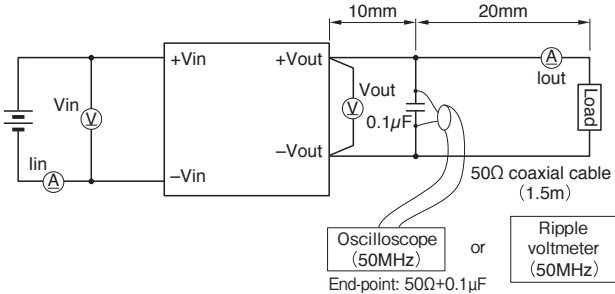
Parallel connection

Parallel connection is not applicable.

2. Noise reduction methods

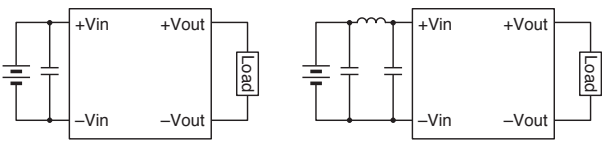
2-1. Output ripple noise measurement method

The measured value of the converter noise may differ depending on the measurement method. Measurement should be conducted in a position close to the output terminal. When connecting a probe, do not allow a loop to be configured in order not to pick up flux. As well, note that the spike voltage greatly differs depending on the ripple voltmeter and frequency band of the oscilloscope. Our noise measurement is conducted by the wiring shown in the figure below and in the frequency band of 50MHz.

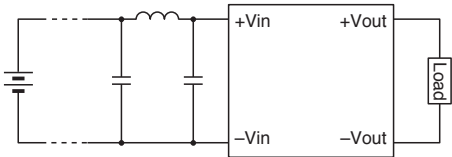


2-2. Input ripple noise

This series is equipped with a built-in capacitor for input. However, by connecting a capacitor with around 10µF, input ripple noise and input return noise can be reduced.



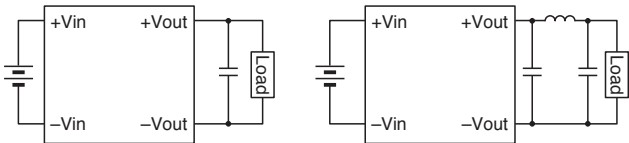
When the distance to the input of the converter from the input power supply is long, attach a capacitor as close as possible to the input terminal.



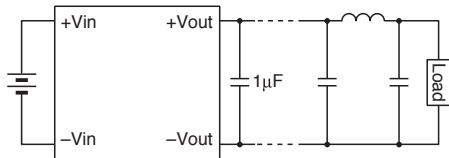
When the distance to the input of the converter from the input power supply is long, the impedance of the input line can become high, causing high spike noise. In this case, it is recommended to connect a capacitor as close as possible to the input of the DC-DC converter.

2-3. Output ripple & noise

To reduce Output ripple & noise, connect a capacitor to the output of the converter. In addition, reduction can be enhanced if a π type filter is incorporated as shown in the figure below. In this case, use of a coil with around 100µH is recommended.



When the distance to the load from the output of the converter is long, connect the capacitor as close as possible to the load. To reduce output spike noise, connect a ceramic capacitor with around 1µF to the output of the converter.



2-4. Capacity of external capacitor connected to output

Note that if a capacitor with capacity over the value shown in the table below is connected to the output, or several capacitors with low impedance are connected in parallel, operation of the converter may become unstable.

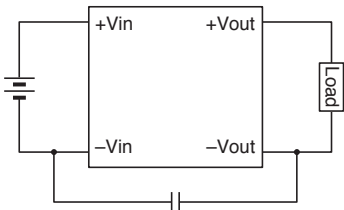
Model name	Electrostatic capacitance (µF) max.
CC1R5-xx03Sx-E	100
CC1R5-xx05Sx-E	100
CC1R5-xx12Sx-E	47
CC1R5-xx12Dx-E	22
CC3-xx03Sx-E	220
CC3-xx05Sx-E	220
CC3-xx12Sx-E	100
CC3-xx12Dx-E	47
CC6-xx03Sx-E	470
CC6-xx05Sx-E	470
CC6-xx12Sx-E	220
CC6-xx12Dx-E	100
CC10-xx03Sx-E	470
CC10-xx05Sx-E	470
CC10-xx12Sx-E	220
CC10-xx12Dx-E	100

2-5. Common mode noise

For products other than with 10W, capacitors are not connected between the primary GND and the secondary GND. To reduce common mode noise, connect a capacitor with around 1000pF between the primary GND and the secondary GND, as shown in the figure below.

In this case, note that if the capacitor that is connected is too large, coupling capacitance between input and output becomes large.

Also be careful about the withstand voltage of the capacitor (500V or over is desirable with consideration of the insulation withstand voltage).



For products with 10W, capacitors with 1000pF are internally connected between primary and secondary.

2-6. Radiation noise

Radiation noise of the converter can be reduced by connecting the case terminal to the input or output GND terminal. The effectiveness varies depending on the device. Check it on the actual device.

Regarding wiring, use GND line and solid pattern for the bottom of the converter as much as possible.

- SMD models are not equipped with case terminals.

3. Soldering conditions/Cleaning conditions

3-1. Soldering conditions

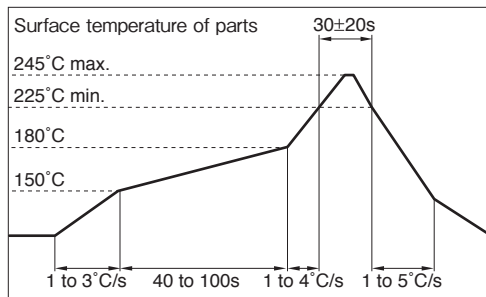
- Soldering conditions
- DIP models / SIP models

Observe the following conditions in soldering board.

Solder dip	260°C, 10s max., 1 time
Soldering copper	380°C, 3s max., 1 time/PIN

SMD models

Lead-free soldering / High-temperature reflow process



The reflow must be 1 time only.
(Do not reflow with the on-board module on the motherboard underside.)

3-2. Cleaning method

It is recommended not to clean the board after soldering. If cleaning is required, brush only the terminals so that the cleaning liquid does not adhere to the product. Then, dry up thoroughly after washing.